## HAMILTON, BROOK, SMITH & REYNOLDS, P.C.

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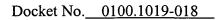
**CORRESPONDENCE ADDRESS** 

Application Number	10/630,458
Filing Date	July 30, 2003
First Named Inventor	Michael D. Borenstein
Confirmation Number	9036
Group Art Unit	2855
Examiner Name	not yet assigned
Attorney Docket Number	0100.1019-018

*Title* 

APPARATUS AND METHODS FOR HEAT LOSS PRESSURE MEASUREMENT

	I/We	hereby appoint
	[X]	the attorneys/agents associated with Customer No. 021005
	[]	Practitioner(s) named below:
	as my applic there	y/our attorneys/agents to prosecute the application identified above, including any continuation or divisional cations thereof, and to transact all business in the United States Patent and Trademark Office connected with.
	The o	correspondence address for the above-identified application is:
	[X]	Customer Number 021005
		Hamilton, Brook, Smith & Reynolds, P.C.
		530 Virginia Road
		P.O. Box 9133
		Concord, Massachusetts 01742-9133
	[]	Other
	Pleas	se direct all telephone calls and facsimiles to:
	Nam	e James M. Smith, Esq. Tel. No. 978-341-0036 Fax No. 978-341-0136
-	l am	the ·
		Applicant/Inventor.
		, pp. noant involves.
	[X]	Authorized representative of the Assignee, Helix Technology Corporation, of the entire interest. See 37 C.F.R. § 3.71. A Statement under 37 C.F.R. §3.73(b) is enclosed.
	[]	Authorized representative of the Assignee, [ ], together with [ ], of the entire interest. A Statement under 37 C.F.R. § 3.73(b) is enclosed.
		/ SIGNATURE of Applicant or Assignee of Record
	Name	& Title Charles G. Chappell, Assistant Secretary
	Signat	uro ( )
	Date	November 6,2003
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## STATEMENT UNDER 37 C.F.R. § 3.73(b)

Applica	ant:	Michael D. Borenstein	
Applica	ation No.:	10/630,458	Filed: July 30, 2003
For:		APPARATUS AND METHODS	FOR HEAT LOSS PRESSURE MEASUREMENT
	Helix T	echnology Corporation (Name of Assignee)	, a corporation , (Type of Assignee, e.g., corporation, partnership, university, government agency, etc.)
states th	nat it is		
A.	[X]	the assignee of the entire right, tit	le and interest in the patent application identified above; or
В.	[ ]	an assignee together with [ above.	] of the entire right, title and interest in the patent application identified
The rigi	ht, title ar	nd interest of the above-named assi	gnee in the patent application identified above is established by virtue of:
A. [X]			tent application identified above. The assignment was recorded in the Patent and e, or a copy thereof is attached.
OR			
B.[]	A chain	of title from the inventor(s) of the	patent application identified above, to the current assignee as shown below:
	1.	From: The document was recorded in the Reel, Frame	
	2.	From:	
	3.	From:	To:
		The document was recorded in the	
	[ ] Ad	ditional documents in the chain of	title are listed on a supplemental sheet.
The unc	dersigned	(whose title is supplied below) is a	authorized to act on behalf of the assignee.
Date:	MOVE	1BER 6, 2003	<u> </u>
Name:_	Charles	G. Chappell	_
Γitle:_/	Assistan	at Secretary	
Signatu	-	/	_
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## **ASSIGNMENT**

WHEREAS, I, Michael D. Borenstein, have invented a certain improvement in Apparatus and Methods for Heat Loss Pressure Measurement, described in an application for Letters Patent of the United States, the specification of which:

[A]	States Patent Office;
[]	was filed on [ ] as Application No. [ ];
[]	was patented under U.S. Patent No. [ ] on [ ].

WHEREAS, Helix Technology Corporation (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the State of Delaware and having a usual place of business at Mansfield Corporate Center, Nine Hampshire Street, Mansfield, Massachusetts 02048-9171, desires to acquire an interest therein in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by me had this assignment and sale not been made; I hereby convey all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. I hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, I hereby further agree for myself and my executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving

of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, I do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, I have hereunto set my hand and affixed my seal the date set forth below.

Inventor's Signature: Milarl D. Coreus Lein
Michael D. Borenstein
State/Commonwealth
of Celorado
County of Boulper
Then personally appeared before me the above-named Michael D. Borenstein and acknowledged that he/she executed the foregoing instrument as his/her free act and deed this

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